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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	٩	AT	TORNEY DOCKET NO.
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Please find below and/or attached an Office communication concerning this application or proceeding.

**Commissioner of Patents and Trademarks** 

:		Application No.	Applicant(s)		
	Office Action Comme	09/501,033	MESS, LEONARD E		
	Office Action Summary	Examiner	Art Unit		
		VINH P NGUYEN	2858		
Pariod fo	- The MAILING DATE of this communication app	ears on the cover sheet with the	correspondence address		
Period fo	ORTENED STATUTORY PERIOD FOR REPL	Y IS SET TO EXPIRE 3 MONT	H(S) FROM		
THE - Exte after - If the - If NC - Failu - Any I	MAILING DATE OF THIS COMMUNICATION.  nsions of time may be available under the provisions of 37 CFR 1.1  SIX (6) MONTHS from the mailing date of this communication.  e period for reply specified above is less than thirty (30) days, a repl  period for reply is specified above, the maximum statutory period  are to reply within the set or extended period for reply will, by statute  reply received by the Office later than three months after the mailin  ed patent term adjustment. See 37 CFR 1.704(b).	136 (a). In no event, however, may a reply be ly within the statutory minimum of thirty (30) o will apply and will expire SIX (6) MONTHS fro e, cause the application to become ABANDOI	e timely filed  lays will be considered timely, om the mailing date of this communication NED (35 U.S.C. § 133).		
1)[	Responsive to communication(s) filed on 14 i	February 2001 .			
2a)[·	This action is <b>FINAL</b> . 2b) The	nis action is non-final.			
3)	Since this application is in condition for allowed losed in accordance with the practice under	ance except for formal matters, Ex parte Quayle, 1935 C.D. 11	prosecution as to the merits is , 453 O.G. 213.		
Dispositi	ion of Claims				
4)	Claim(s) 1-61 is/are pending in the application	٦.			
	4a) Of the above claim(s) is/are withdraw	wn from consideration.			
5)	Claim(s) is/are allowed.				
6)[-	Claim(s) <u>1-61</u> is/are rejected.				
7)	Claim(s) is/are objected to.				
8) 🗌	Claims are subject to restriction and/or	r election requirement.			
Applicati	on Papers				
9)	The specification is objected to by the Examine	er.			
10)	The drawing(s) filed on is/are objected t	to by the Examiner.			
11)	The proposed drawing correction filed on	_ is: a)□ approved b)□ disa <sub>l</sub>	oproved.		
12)	The oath or declaration is objected to by the Ex	xaminer.			
Priority u	ınder 35 U.S.C. § 119				
13)	Acknowledgment is made of a claim for foreign	n priority under 35 U.S.C. & 1196	a)-(d) or (f)		
_	☐ All b)☐ Some * c)☐ None of:	, ,			
	1. Certified copies of the priority documents	s have been received.			
	2. Certified copies of the priority documents have been received in Application No				
	3. Copies of the certified copies of the prior application from the International Buree the attached detailed Office action for a list	rity documents have been receiv reau (PCT Rule 17.2(a)).	ved in this National Stage		
14)	Acknowledgement is made of a claim for dome	estic priority under 35 U.S.C. § 1	19(e).		
Attachment	(c)				
Attachment	ce of References Cited (PTO-892)	40)	(DTO 442) S		
16) Notic	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449) Paper No(s) J	19) Notice of Informa	ary (PTO-413) Paper No(s) al Patent Application (PTO-152)		
S Patent and Tra PTO-326 (Rev		tion Summary	Part of Paper No. 11		

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1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-61 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lim et al. (Pat # 5,530,376).

As to claims 1-9, 17-24,28-30,33-35,37-38,40-42,44-47,49-52,54-57 and 59-61, Lim et al disclose a carrier for burn-in/testing of non-package die as shown in figure 1,2 and 4 having an interposer and a resilient connector (1-3,4,13) for holding the semiconductor device (6) stationary relative to the interposer. According to Lim et al., the interposer comprises substrate (12) made of ceramic material, a plurality of electrical conductors (16) with receiving ends (17) projected and disposed within a recess of the substrate (12), for connecting to a semiconductor device (6). It would have been obvious for one of ordinary skill in the art to consider that the surface in which the electrical conductors (16) and the receiving ends (17) formed thereon is an outermost surface meanwhile the bottom surface on an opposite side of the substrate (12) is an inner most surface. Furthermore, the materials for the substrate are well known in the art.

As to claims 10-11,15,16,31-32, the material for the connector would have been an obvious design choice as long as it can bias and hold the semiconductor device in place properly.

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As to claims 12, it appears that the semiconductor of Lim et al is exposed to the atmosphere to thereby dissipate heat to the atmosphere. As to claim 13, it appears that the connector of Lim et al removably connects the semiconductor device to the interposer. As to claim 14, it appears that the connector of Lim et al is a resilient biasing clip. As to claims 24-25, 36 the materials for the substrate such as "Boron Nitride" or "alumina", etc... would have been well known insulated materials in the art. As to claims 39,43,48,53 and 58, it would have been well known for one of ordinary skill in the art to adhessively connects the semiconductor device to the interposer.

3. Claims 1-61 are rejected under 35 U.S.C. 103(a) as being unpatentable over James (pat # 3,354,394).

As to claims 1-9, 17-24,28-30,33-35,37-38,40-42,44-47,49-52,54-57 and 59-61, James disclose in figures # 1-2 an interposer having an insulated substrate (2) with an outermost surface and being configured for receiving a semiconductor device under test (22), a plurality of conductors (5) with receiving ends formed on the substrate (2) for making contact with the device under test (22) and terminal ends connected to a test apparatus, and connectors (3,6,7) for holding the device under test (22) stationary relative to the interposer. James does not particularly indicate the material for the substrate. However, the selected material for the substrate from a group consisting of insulating ceramic material, inorganic ceramic material, glass, alumina, glass ceramic, nonmetalli nitride, aluminum nitride, nonmetalic carbide, alumina

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with silicates, alumina with derivative of silicates, boron nitrides, aluminum nitrides, oxides of Silicon, silicate glass, nucleated substantially crystalline glass and mixtures and derivatives thereof would have been obvious and well known in the art.

As to claims 10-11,15,16,31-32, the material for the connector would have been an obvious design choice as long as it can bias and hold the semiconductor device in place properly. As to claims 12, it appears that the semiconductor of James is exposed to the atmosphere to thereby dissipate heat to the atmosphere. As to claim 13, it appears that the connector of James removably connects the semiconductor device to the interposer. As to claim 14, it appears that the connector of James is a resilient biasing clip. As to claims 24-25, 36 the materials for the substrate such as "Boron Nitride" or "alumina", etc... would have been well known insulated materials in the art. As to claims 39,43,48,53 and 58, it would have been well known for one of ordinary skill in the art to adhessively connects the semiconductor device to the interposer

- 4. Applicant's arguments with respect to claims 1-61 filed on 02/14/2001 have been considered but are most in view of the new ground(s) of rejection.
- Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE

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MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to VINH P. NGUYEN whose telephone number is (703) 305-4914.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 305-4900.

VINH P. NGUYEN PRIMARY EXAMINER ART UNIT 2858

04/11/2001